

1.8 - Pulsed (Note 1 & 3)  $\mathsf{P}_{\mathsf{D}}$ Maximum Power Dissipation 0.3 (Note 2) T<sub>J</sub>,T<sub>STG</sub> Operating and Storage Temperature Range -55 to 150 Electrostatic Discharge Rating MIL-STD-883D Human Body ESD 6 Model (100pf/1500Ohm) THERMAL CHARACTERISTICS  $\mathsf{R}_{\theta\mathsf{J}\mathsf{A}}$ Thermal Resistance, Junction-to-Ambient (Note 2) 415

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FDG6323L Rev.C

W

°C

kV

°C/W

Electrical Characteristics (T <sub>A</sub> = 25°C unless otherwise noted)								
Symbol	Parameter	Conditions	Min	Тур	Max	Units		
OFF CHA	RACTERISTICS			•	•	•		
I <sub>FL</sub>	Forward Leakage Current	$V_{IN} = 8 V, V_{ONOFF} = 0 V$			1	μA		
ON CHAR	ACTERISTICS (Note 3)							
V <sub>DROP</sub>	Conduction Voltage Drop	$V_{IN} = 5 \text{ V}, V_{ONOFF} = 3.3 \text{ V}, I_{L} = 0.36 \text{ A}$		0.14	0.2	V		
		$V_{IN} = 2.5 \text{ V}, V_{ONOFF} = 3.3 \text{ V}, I_L = 0.27 \text{ A}$		0.15	0.2			
R <sub>(ON)</sub>	Q2 - Static On-Resistance	$V_{GS} = -5 V, I_{D} = -0.6 A$		0.41	0.55	Ω		
		$V_{GS} = -2.5 \text{ V}, I_{D} = -0.5 \text{ A}$		0.58	0.75			
l,	Load Current	$V_{\text{DROP}} = 0.2 \text{ V}, \text{ V}_{\text{IN}} = 5 \text{ V}, \text{ V}_{\text{ONOFF}} = 3.3 \text{ V}$	0.36			А		
		$V_{\text{DROP}} = 0.2 \text{ V}, V_{\text{IN}} = 2.5 \text{ V}, V_{\text{ONOFF}} = 3.3 \text{ V}$	0.27			]		

Notes:

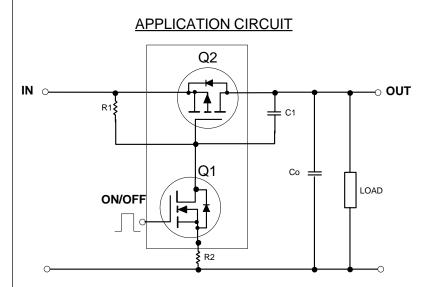
1. Range of  $V_{in}$  can be up to 8V, but  $R_1$  and  $R_2$  must be scaled such that  $V_{GS}$  of Q2 does not exceed -8V.

2. R<sub>8,4</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.

 $R_{_{BJC}}$  is guaranteed by design while  $R_{_{BCA}}$  is determined by the user's board design.

3. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2.0%

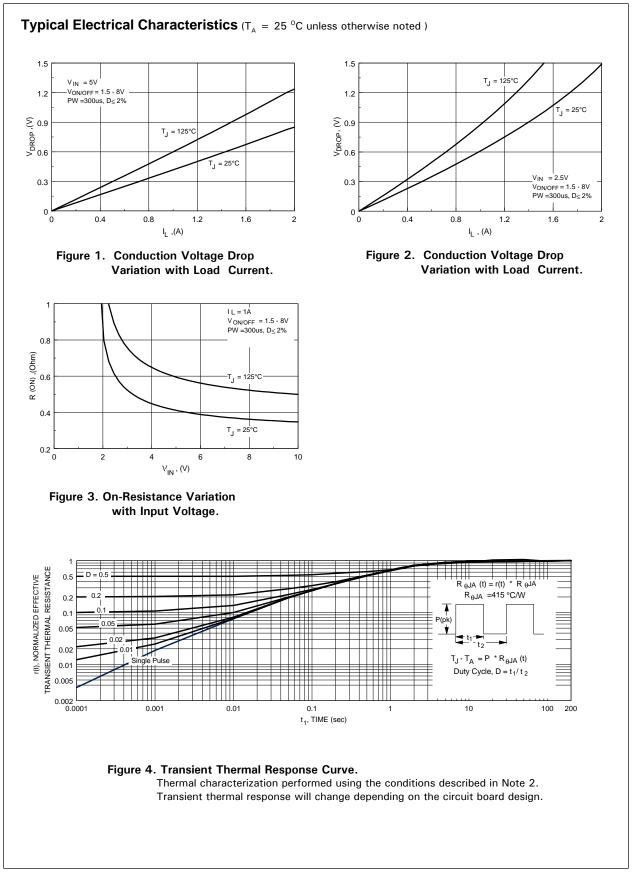
# FDG6323L Load Switch Application



## **External Component Recommendation**

R1 is required to turn Ω2 off. R2 is optional for Slew Rate Control.

For Co  $\leq$  1uF applications: First select R2,100 - 1K $\Omega$ , for Slew Rate control. Then select R1 such that R1/R2 ratio maintains between 10 - 100.



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